# **MOSFET** – Power, N-Channel, SUPERFET III, Easy Drive

### 650 V, 14 A, 199 m $\Omega$

#### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advance technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET is very suitable for various power system miniaturization and higher efficiency.

#### Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 170 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 30 \text{ nC}$ )
- Low Effective Output Capacitance (Typ. Coss(eff.) = 277 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

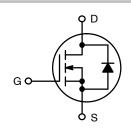
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar



#### **ON Semiconductor®**

#### www.onsemi.com

V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX I <sub>D</sub> MA	
650 V	199 m $\Omega$ @ 10 V	14 A

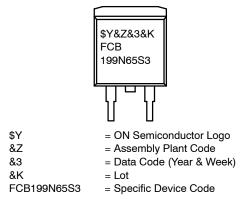


POWER MOSFET



CASE 418AJ

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Paran	Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		650	V
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
I <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	14	А
		Continuous (T <sub>C</sub> = 100°C)	9	
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)	35	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		76	mJ
I <sub>AS</sub>	Avalanche Current (Note 1)		2.5	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		0.98	mJ
dv/dt	MOSFET dv/dt		100	
	Peak Diode Recovery dv/dt (Note 3)		20	
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	98	W
		Derate Above 25°C	0.79	W/°C
TJ, T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Solder	ing, 1/8" from Case for 5 s	300	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 2.5 \text{ A}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 7 \text{ A}$ , di/dt  $\le 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} \le 400 \text{ V}$ , starting  $T_J = 25^{\circ}\text{C}$ .

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\thetaJC}$	Thermal Resistance, Junction to Case, Max.	1.27	°C/W
	Thermal Resistance, Junction to Ambient, Max. (Note 4)	40	

4. Device on 1 in<sup>2</sup> pad 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Reel Size	Tape Width	Shipping <sup>†</sup>
FCB199N65S3	FCB199N65S3	D <sup>2</sup> -PAK	330 mm	24 mm	800 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS	-				
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V
		$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$		0.6		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
		$V_{DS}$ = 520 V, $T_{C}$ = 125°C		0.89		
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V},  \text{V}_{DS} = 0 \text{ V}$			±100	nA
ON CHARACTE	RISTICS			-	-	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 0.36$ mA	2.5		4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7 A		170	199	mΩ
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 7 \text{ A}$		10		S
YNAMIC CHA	RACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz		1225		pF

.00		50 00		
C <sub>oss</sub>	Output Capacitance		30	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	277	pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	43	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 7 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	30	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	— (Note 5)	7.4	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		13	nC
ESR	Equivalent Series Resistance	f = 1 MHz	7	Ω

SWITCHING CHARACTERISTICS

t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 7 \text{ A},$	19	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω (Note 5)	23	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		52	ns
t <sub>f</sub>	Turn-Off Fall Time		15	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current			14	А
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current			35	А
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS}$ = 0 V, $I_{SD}$ = 7 A		1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, \text{I}_{SD} = 7 \text{ A},$	256		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/µs	3.5		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Essentially independent of operating temperature typical characteristics.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

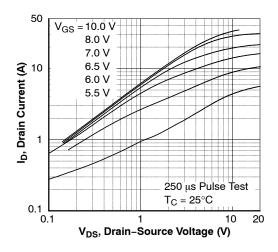
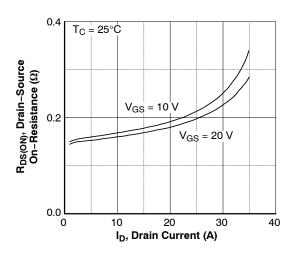
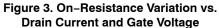


Figure 1. On-Region Characteristics





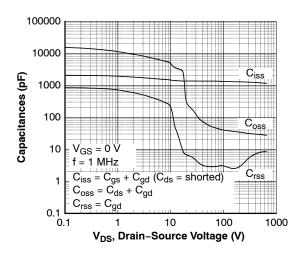
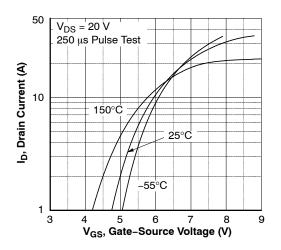


Figure 5. Capacitance Characteristics



**Figure 2. Transfer Characteristics** 

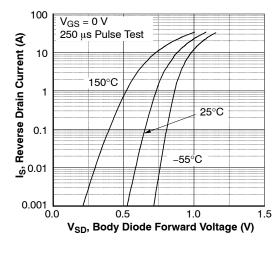


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

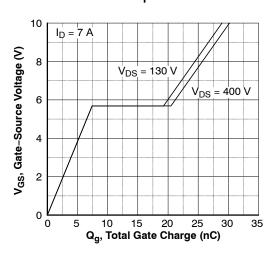


Figure 6. Gate Charge Characteristics

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

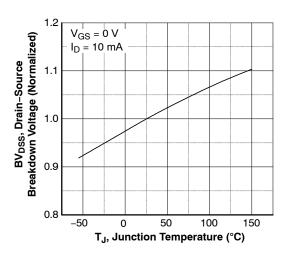


Figure 7. Breakdown Voltage Variation vs. Temperature

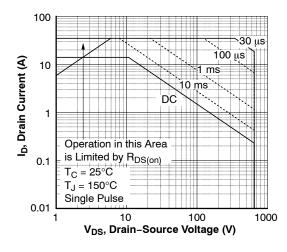


Figure 9. Maximum Safe Operating Area

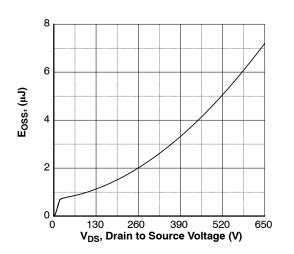


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

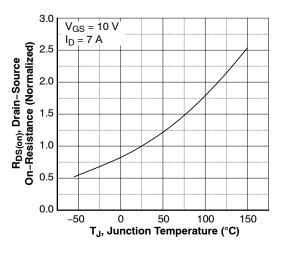


Figure 8. On–Resistance Variation vs. Temperature

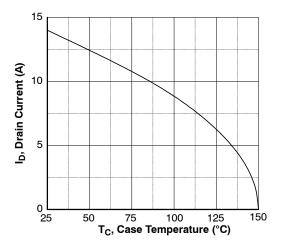


Figure 10. Maximum Drain Current vs. Case Temperature

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

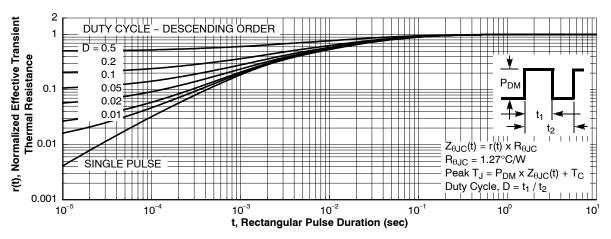
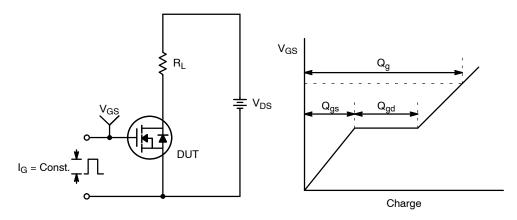


Figure 12. Transient Thermal Response Curve





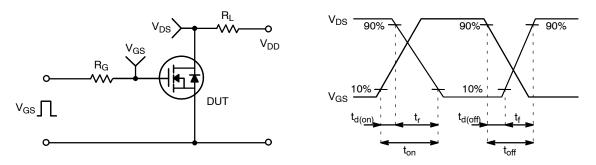
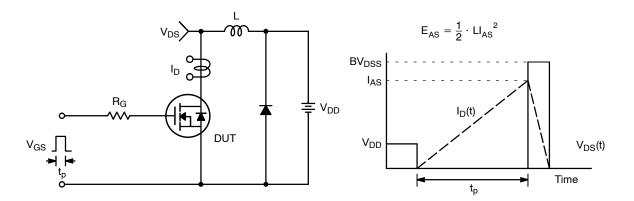


Figure 14. Resistive Switching Test Circuit & Waveforms





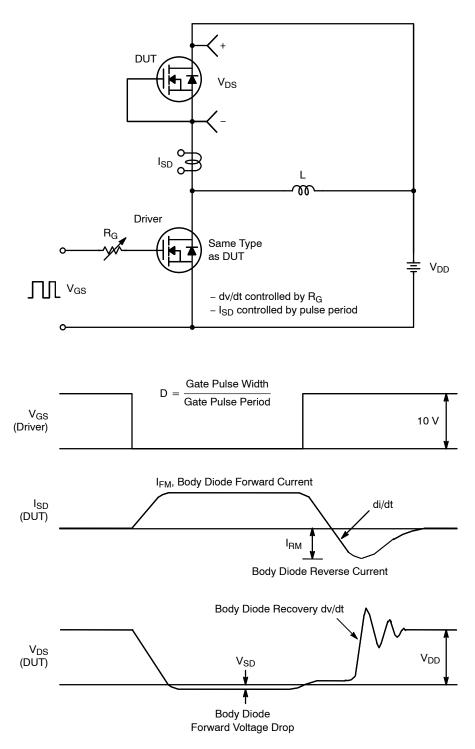
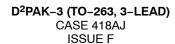


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

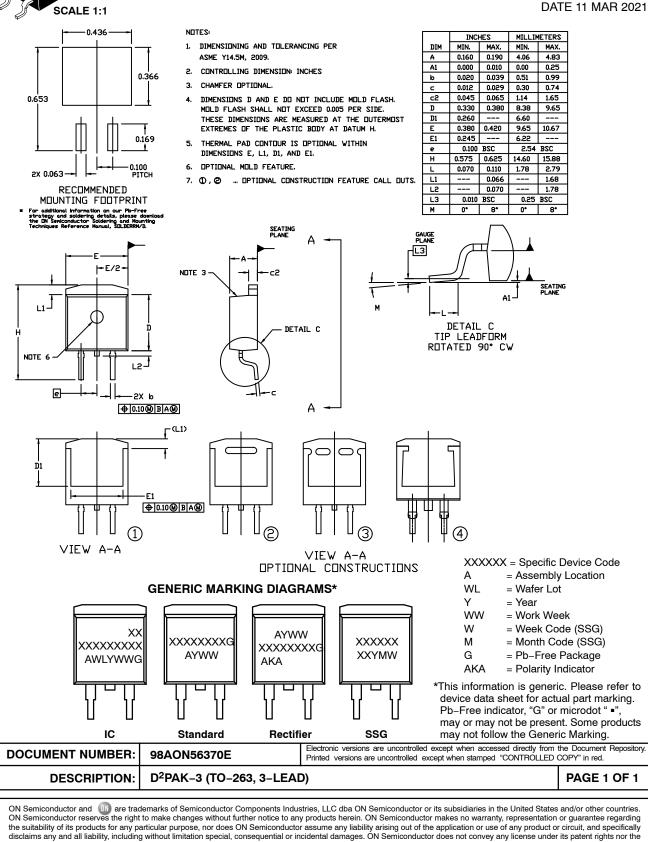
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#### **MECHANICAL CASE OUTLINE** PACKAGE DIMENSIONS









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